

# HSP

**NOTES:**

Current Rating: 2.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G, F UL94V-0

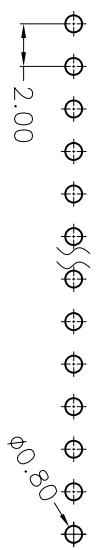
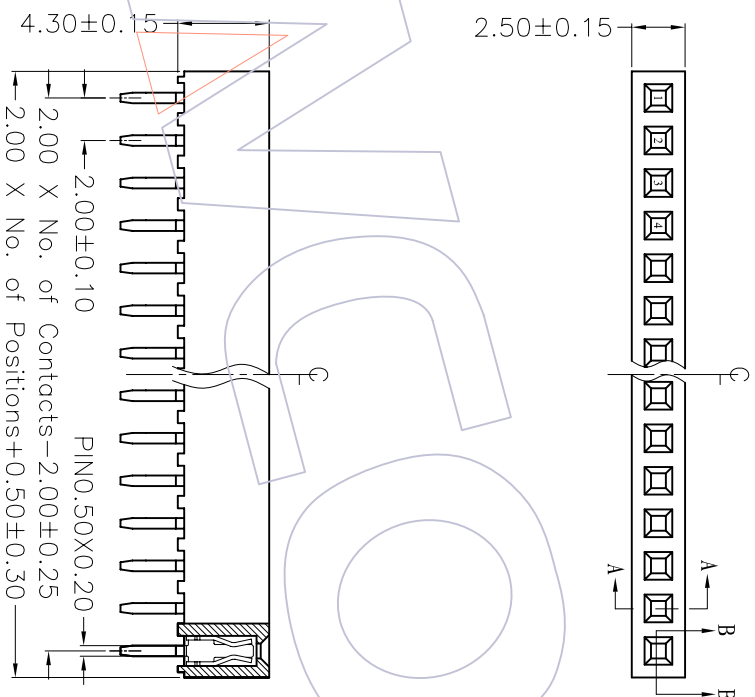
## Ordering Information

2243 - 1 XX S XX CUNT 1

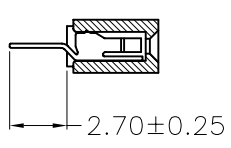
No. of Pins per ROW: 02~40PIN

Contact Plating:  
 GO=Gold Flash  
 G1=3μ"Gold  
 G2=5μ"Gold  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold  
 S0=Gold Flash/Tin  
 S1=3μ"Gold/Tin  
 S2=5μ"Gold/Tin  
 S3=10μ"Gold/Tin  
 S4=15μ"Gold/Tin  
 S5=30μ"Gold/Tin  
 SN=Tin

Packaging:  
 T=Tube  
 P=Tube+CAP



Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



SECTION A-A

SECTION B-B

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/28	NEW			X.X ±0.40	<i>MaLi3</i>	3:1	2243-1XXSXXCUNT1	Φ12.00mm SINGLE 180° H=4.30
					X.XX ±0.25	DESIGN	mm		
					X.XXX ±0.15	CHECK	A4		
					Angle ± 3'	APPROVE	1/1		
					DIM TOL	PROJ.	Customer NO.		

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 WAVE HARDWARE ELECTRONICS CO.,LTD